GA10K3CG3 <

MEAS

TE Internal #: GA10K3CG3 TE Internal Description: CHPG-NTC CHIP THERMISTORS View on TE.com >



Sensors > Temperature Sensors > NTC Thermistors Sensors & Probes > Discrete NTC



Discrete NTC Sensor Type: NTC Thermistor

Wire Connection: Solder/Wire Bond

Resistance (at 25°C): 10 kΩ

Tolerance Resistance: ±5%

Beta 25/85 Value: **3976 K**

Features

Product Type Features

| Discrete NTC Sensor Type | NTC Thermistor |
|--------------------------|----------------|
| Tolerance β -Value | ±2 % |
| Signal Characteristics | |

Signal Characteristics

| Beta 25/85 Value | 3976 K |
|--|----------------------|
| Body Features | |
| Wire Connection | Solder/Wire Bond |
| Usage Conditions | |
| Resistance (at 25°C) | 10 kΩ |
| Tolerance Resistance | ± 5 % |
| Discrete NTC Ambient Temperature Range | -40 – 125 °C |
| Temperature Accuracy | ± 1.2 @ 25 °C |
| Maximum Temperature | 125 °C[257 °F] |
| Packaging Features | |
| Discrete NTC Package | Gold Chip Thermistor |
| Product Compliance For compliance documentation, visit the product page on TE.com> | |
| EU RoHS Directive 2011/65/EU | Compliant |



| EU ELV Directive 2000/53/EC | Not Yet Reviewed |
|---|---|
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC |
| Halogen Content | Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free |
| | |

Solder Process Capability

Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts



Documents

Datasheets & Catalog Pages Leadless_Chip_Gold_10K3CG

English